

2A SURFACE-MOUNT FAST RECOVERY BRIDGE RECTIFIER

Product Summary

V _{RRM} (V)	I _F (A)	V _F Max (V)	I _R Max (μA)
1000	2	1.3	5

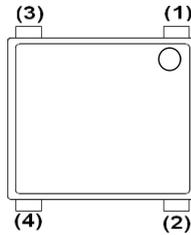
Mechanical Data

- Package: SOPA-4
- Package Material: Plastic Material, UL Flammability Classification 94V-0 (No Br. Sb, Cl)
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (3)
- Polarity Indicator: Symbol Molded on Body
- Weight: 0.93 grams (Approximate)

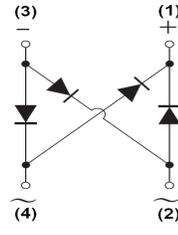
SOPA-4 (Type WX)



Top View



Pin Diagram



Internal Schematic

Features

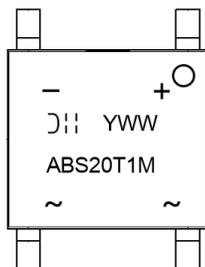
- Glass Passivated Die Construction
- Rating to 1000V PRV
- Ideal for SMT Manufacturing
- Reliable Low Cost Construction Utilizing Molded Plastic Technique
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](mailto:contact@diodes.com) or your local Diodes representative. <https://www.diodes.com/quality/product-definitions/>**

Ordering Information (Note 4)

Part Number	Package	Packing	
		Qty.	Carrier
ABS20T1M	SOPA-4 (Type WX)	3000	Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



ABS20T1M = Product Type Marking Code
 JII = Manufacturer's Code Marking
 YWW = Date Code Marking
 Y = Last Digit of Year (ex: 4 = 2024)
 WW = Week Code (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	1000	V
Maximum DC Blocking Voltage	V _{DC}	1000	V
Maximum Average Rectified Output Current	I _{F(AV)}	2 1	A
Peak Forward Surge Current 8.3ms Single Half Sine Wave Superimposed on Rated Load.	I _{FSM}	T _J = +25°C	60
		T _J = +125°C	48
Peak Forward Surge Current 1.0ms Single Half Sine Wave Superimposed on Rated Load.	I _{FSM}	T _J = +25°C	120
		T _J = +125°C	96
I ² t Rating for Fusing (t = 8.3ms)	I ² t	14.9	A ² s
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics

Characteristic	Test Conditions	Symbol	Typ	Max	Unit
Forward Voltage	I _F = 2A T _J = +25°C	V _F	—	1.3	V
Leakage Current	V _R = 1000V T _J = +25°C T _J = +125°C	I _R	—	5 500	μA
Reverse Recovery Time	I _F = 0.5A, I _{rr} = 0.25A, I _R = 1.0A	t _{rr}	—	500	ns
Typical Total Junction Capacitance (Note 5)		C _T	27	—	pF

Thermal Characteristics

Characteristic	Symbol	Typ	Unit
Typical Thermal Resistance (Note 6)	R _{θJC}	6	°C/W
	R _{θJL}	15	
	R _{θJA}	40	

- Notes:
5. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
 6. Thermal resistance junction to case, lead and ambient. Unit mounted on glass-epoxy substrate with 2oz/ft² 30mm x 30mm copper pad.

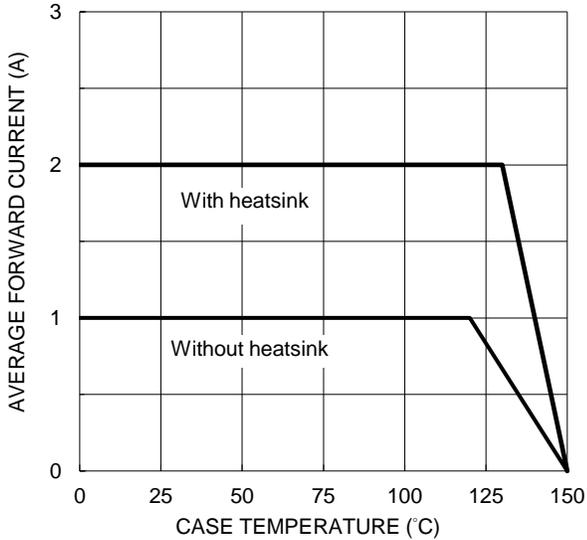


Figure 1. Forward Current Derating Curve

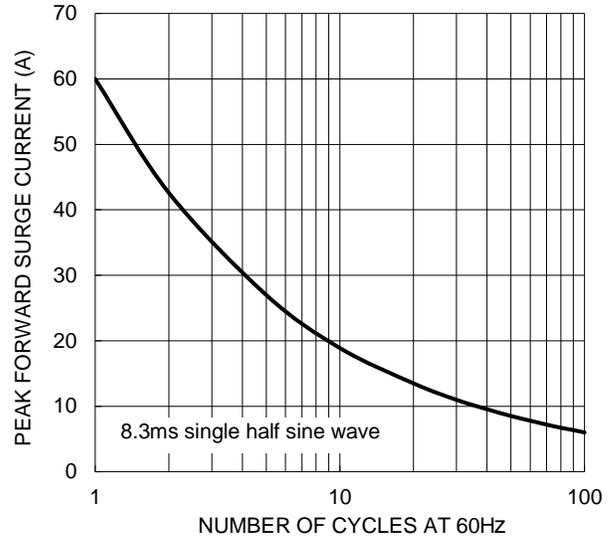


Figure 2. Maximum Non-Repetitive Surge Current

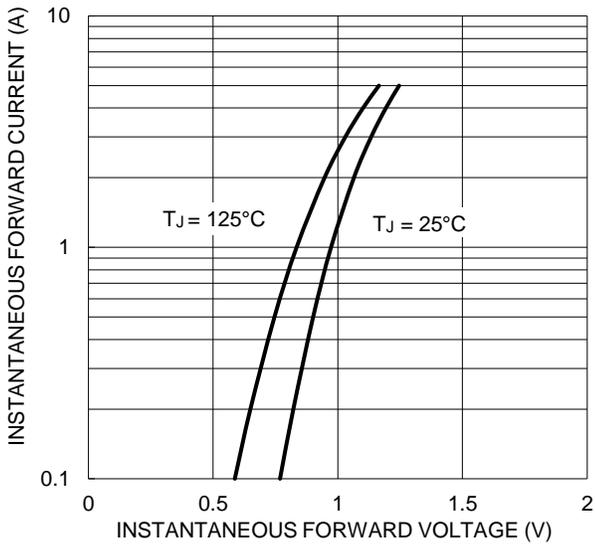


Figure 3. Typical Forward Characteristics

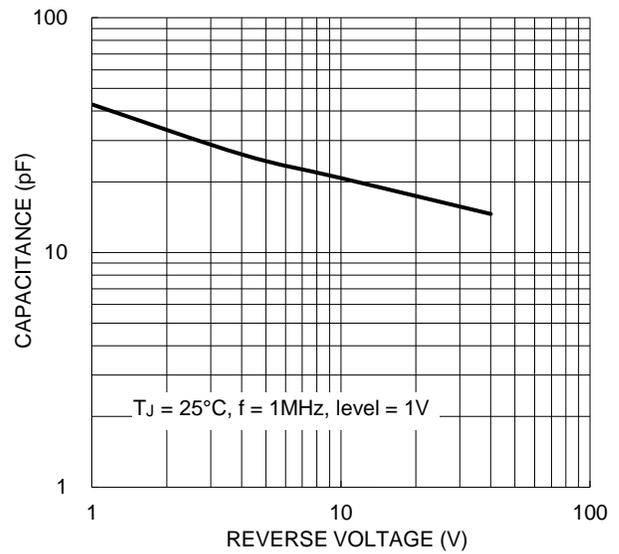


Figure 4. Typical Junction Capacitance

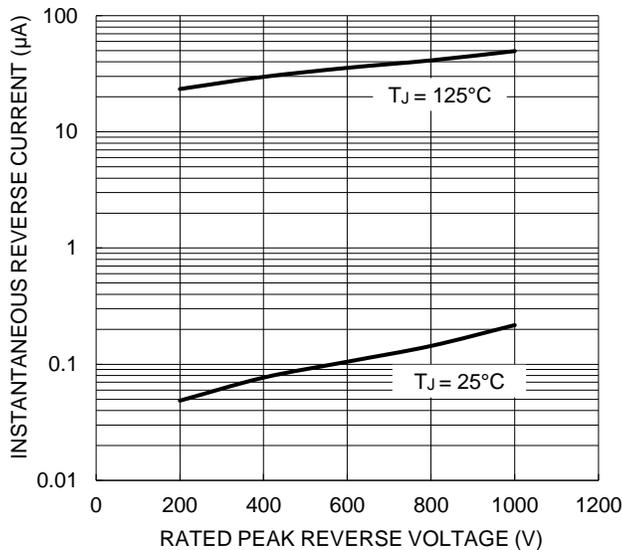
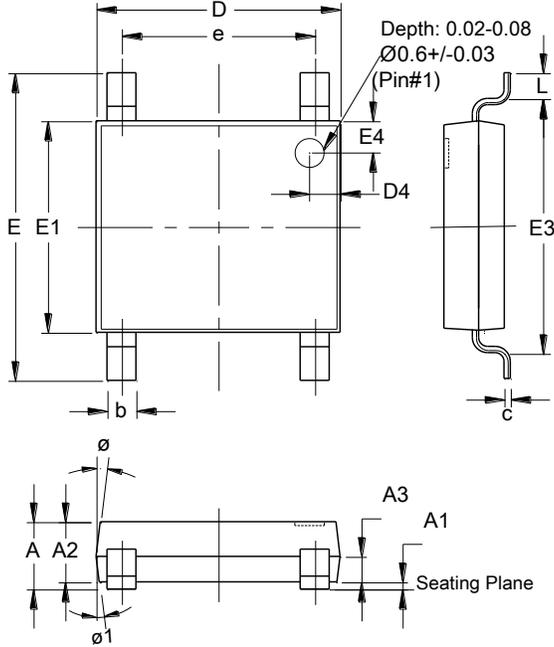


Figure 5. Typical Reverse Characteristics

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOPA-4 (Type WX)

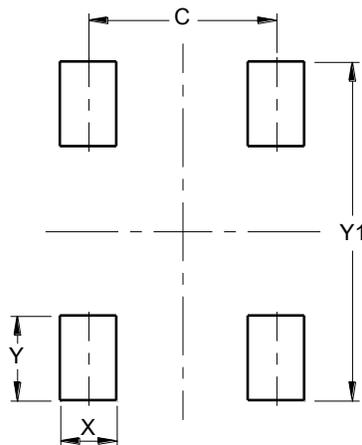


SOPA-4 (Type WX)			
Dim	Min	Max	Typ
A	1.20	1.40	--
A1	0.00	0.15	--
A2	1.20	1.30	--
A3	0.43	0.63	--
b	0.50	0.80	--
c	0.10	0.30	--
D	4.85	5.25	--
D4	0.45	0.85	--
e	3.80	4.20	--
E	6.40	6.80	--
E1	4.25	4.65	--
E3	5.20	5.60	--
E4	0.45	0.85	--
L	0.40	0.80	--
Ø	--	--	7°
Ø1	--	--	7°
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOPA-4 (Type WX)



Dimensions	Value (in mm)
C	4.00
X	1.20
Y	1.80
Y1	7.20

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